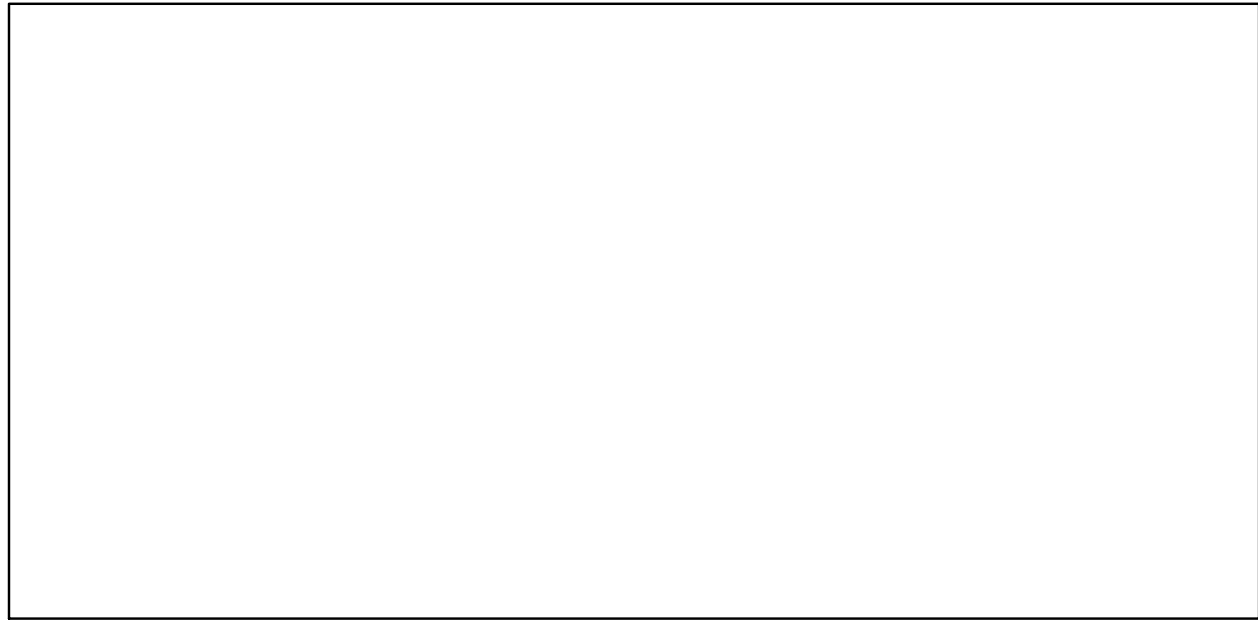


TEXAS INSTRUMENTS		Copper Layer Name		Silkscreen		S Mask		P Mask		Assembly		Fab Drawing
		Top	Bot	Top	Bot	Top	Bot	Top	Bot	Top	Bot	
Board No.	PMP6720	Rev.	C							TA		
Date:	7/5/11	Filename:	PMP6720C	Engineer:	D.PARKS	PCB Dsgnr:	R.SMITH	Modified Date:	(Modification Date)	Software:	PADS v9.3	



TEXAS INSTRUMENTS		Copper Layer Name		Silkscreen		S Mask		P Mask		Assembly		Fab Drawing	
Board No.	Rev.	Top	Bot	Top	Bot	Top	Bot	Top	Bot	Top	Bot		
PMP6720	C										BA		
Date: 7/5/11	Filename: PMP6720C	Engineer: D.PARKS	PCB Dsgnr: R.SMITH	Modified Date: (Modification Date)				Software: PADS v9.3					

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